## DATA SHEET

Solid State Relay OCMOS FET

# PS7113-1A,-2A,PS7113L-1A,-2A

### 6, 8-PIN DIP, 350 mA CONTINUOUS LOAD CURRENT 1-ch, 2-ch Optical Coupled MOS FET

#### DESCRIPTION

NEC

The PS7113-1A, -2A and PS7113L-1A, -2A are solid state relays containing GaAs LEDs on the light emitting side (input side) and MOS FETs on the output side.

They are suitable for analog signal control because of their low offset and high linearity.

The PS7113L-1A, -2A have a surface mount type lead.

#### FEATURES

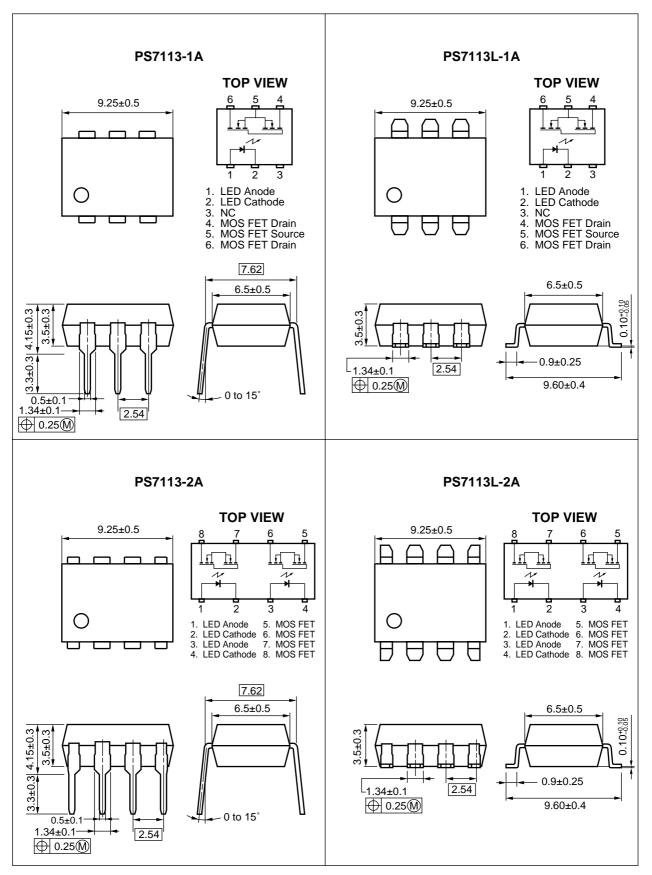
- 1 channel type (1 a output) or 2 channel type (1 a + 1 a output)
- Low LED operating current (IF = 2 mA)
- Designed for AC/DC switching line changer
- Small package (6, 8-pin DIP)
- · Low offset voltage
- PS7113L-1A, -2A: Surface mount type
- UL approved: File No. E72422 (S)
- BSI approved: No. 8245/8246
- CSA approved: No. CA 101391

#### APPLICATIONS

- Exchange equipment
- Measurement equipment
- FA/OA equipment

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#### ORDERING INFORMATION

Part Number	Package	Packing Style	Application Part Number <sup>*1</sup>
PS7113-1A	6-pin DIP	Magazine case 50 pcs	PS7113-1A
PS7113L-1A			PS7113L-1A
PS7113L-1A-E3		Embossed Tape 1 000 pcs/reel	
PS7113L-1A-E4			
PS7113-2A	8-pin DIP	Magazine case 50 pcs	PS7113-2A
PS7113L-2A			PS7113L-2A
PS7113L-2A-E3		Embossed Tape 1 000 pcs/reel	
PS7113L-2A-E4			

\*1 For the application of the Safety Standard, following part number should be used.

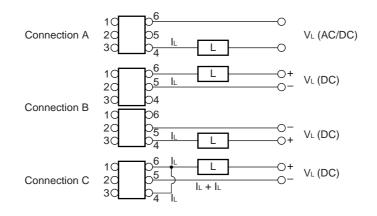
				Rati		
Parameter			Symbol	PS7113-1A, PS7113L-1A	PS7113-2A, PS7113L-2A	Unit
Diode	Forward Current (D	C)	lf	50		mA
	Reverse Voltage		Vr	5.0		V
	Power Dissipation		PD	50		mW/ch
	Peak Forward Curre	IFP	1		А	
MOS FET	Break Down Voltage		VL	100		V
	Continuous Connection A		١L	350		mA
	Load Current <sup>2</sup>	Connection B		450	Ι	
		Connection C		700	-	
	Pulse Load Current <sup>*3</sup> (AC/DC Connection)		Ilp	600		mA
Power Dissipation		PD	560	375	mW/ch	
Isolation Voltage <sup>•₄</sup>			BV	1 500		Vr.m.s.
Total Power Dissipation			Рт	610	850	mW
Operating Ambient Temperature			TA	-40 to +85		°C
Storage Temperature			Tstg	-40 to +100		°C

#### ABSOLUTE MAXIMUM RATINGS (TA = 25 °C, unless otherwise specified)

\*

\*1 PW = 100  $\mu$ s, Duty Cycle = 1 %

\*2 Conditions:  $I_F \ge 2$  mA. The following types of load connections are available.



\*3 PW = 100 ms, 1 shot

\*4 AC voltage for 1 minute at  $T_A = 25$  °C, RH = 60 % between input and output

\*

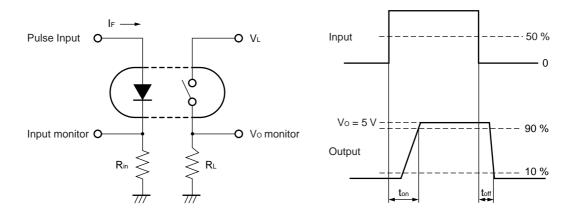
#### **RECOMMENDED OPERATING CONDITIONS (TA = 25 °C)**

Parameter	Symbol	MIN.	TYP.	MAX.	Unit
LED Operating Current	lF	2	10	20	mA
LED Off Voltage	VF	0		0.5	V

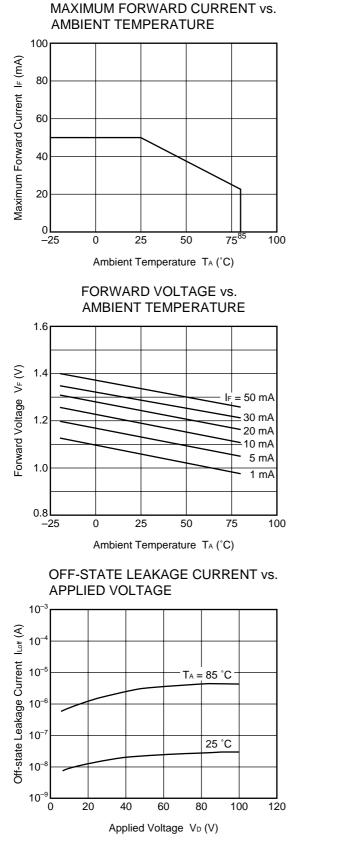
#### ELECTRICAL CHARACTERISTICS (TA = 25 °C)

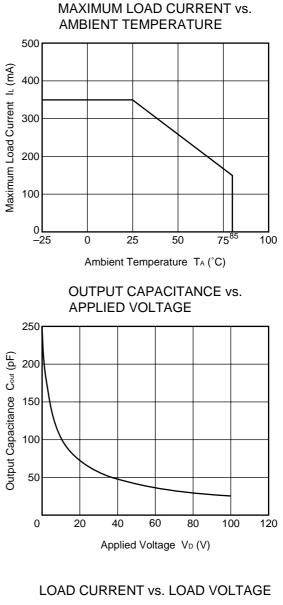
	Parameter	Symbol	Conditions	MIN.	TYP.	MAX.	Unit
Diode	Forward Voltage	VF	IF = 10 mA		1.2	1.4	V
	Reverse Current	Ir	V <sub>R</sub> = 5 V			5.0	μA
MOS FET	Off-state Leakage Current	Loff	V <sub>D</sub> = 100 V		0.03	1.0	μA
	Output Capacitance	Cout	V <sub>D</sub> = 0 V, f = 1 MHz		250		pF/ch
Coupled	LED On-state Current	IFon	I∟ = 350 mA			2.0	mA
	On-state Resistance	Ron1	IF = 10 mA, IL = 10 mA		0.9	2.5	Ω
		Ron2	I⊧ = 10 mA, I∟ = 350 mA, t ≤ 10 ms				
	Turn-on Time <sup>*1</sup>	ton	$I_{F} = 10 \text{ mA}, \text{ Vo} = 5 \text{ V}, \text{ R}_{L} = 500 \Omega,$		1.3	3.0	ms
	Turn-off Time <sup>*1</sup>	toff	PW ≥ 10 ms		0.06	0.2	
	Isolation Resistance	Rı-o	VI-O = 1.0 kVDC	10 <sup>°</sup>			Ω
	Isolation Capacitance	CI-0	V = 0 V, f = 1 MHz		1.1		pF/ch

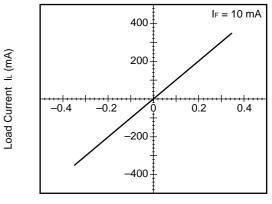
\*1 Test Circuit for Switching Time



#### ★ TYPICAL CHARACTERISTICS (T<sub>A</sub> = 25 °C, unless otherwise specified)



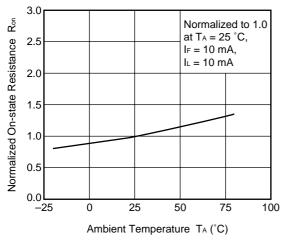




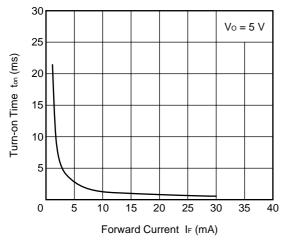
Load Voltage VL (V)

Data Sheet PN10269EJ01V1DS

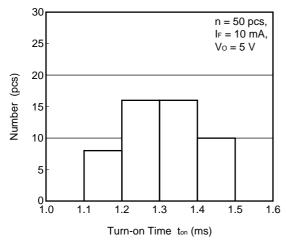
# NORMALIZED ON-STATE RESISTANCE vs. AMBIENT TEMPERATURE



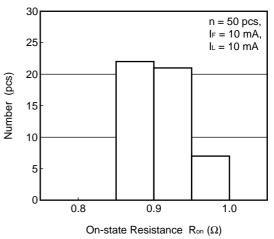
#### TURN-ON TIME vs. FORWARD CURRENT



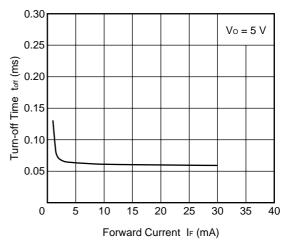
#### TURN-ON TIME DISTRIBUTION



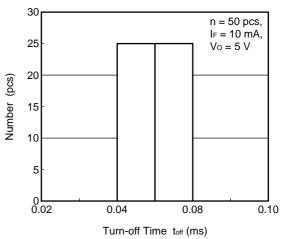
#### **ON-STATE RESISTANCE DISTRIBUTION**

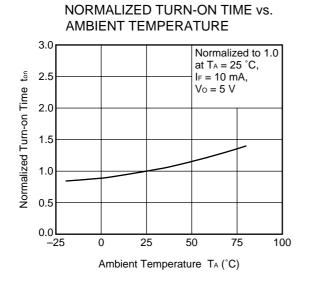


TURN-OFF TIME vs. FORWARD CURRENT

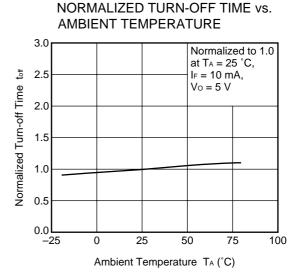


#### TURN-OFF TIME DISTRIBUTION

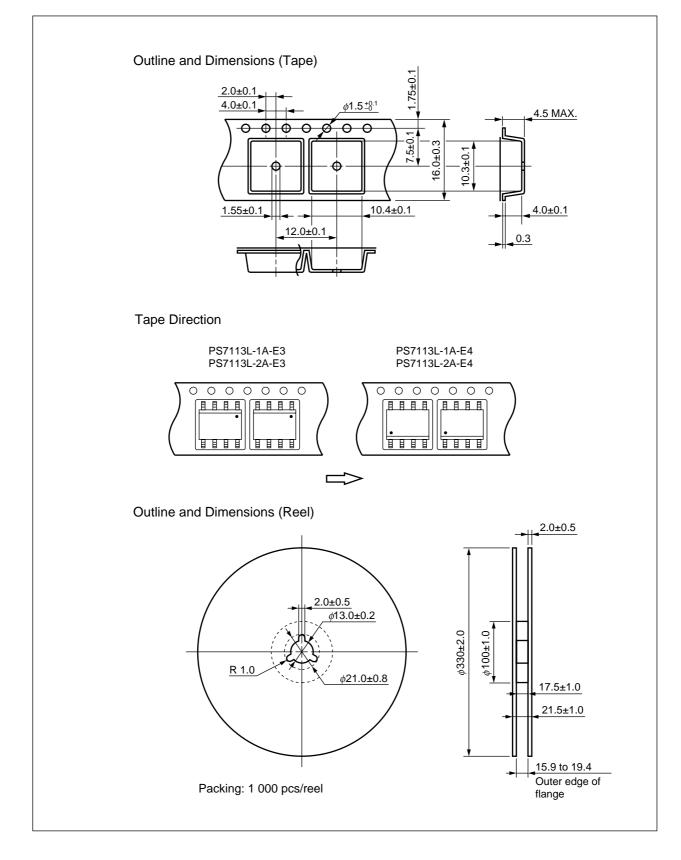




**Remark** The graphs indicate nominal characteristics.



\* TAPING SPECIFICATIONS (in millimeters)



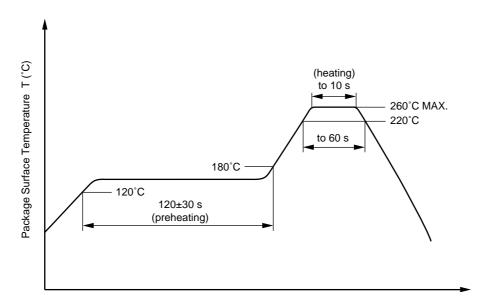
#### ★ RECOMMENDED SOLDERING CONDITIONS

- (1) Infrared reflow soldering
  - Peak reflow temperature
  - Time of peak reflow temperature
  - Time of temperature higher than 220°C
  - Time to preheat temperature from 120 to  $180^\circ\text{C}$
  - Number of reflows
  - Flux

260°C or below (package surface temperature) 10 seconds or less 60 seconds or less 120±30 s Three Rosin flux containing small amount of chlorine (The flux with a

maximum chlorine content of 0.2 Wt% is recommended.)

Recommended Temperature Profile of Infrared Reflow



Time (s)

#### (2) Wave soldering

- Temperature 260°C or below (molten solder temperature)
- Time 10 seconds or less
- Preheating conditions 120°C or below (package surface temperature)
- Number of times
  One
  - Rosin flux containing small amount of chlorine (The flux with a maximum chlorine content of 0.2 Wt% is recommended.)

#### (3) Cautions

• Flux

• Fluxes

Avoid removing the residual flux with freon-based and chlorine-based cleaning solvent.

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M8E 00.4-0110

#### SAFETY INFORMATION ON THIS PRODUCT

Caution GaAs Products	The product contains gallium arsenide, GaAs. GaAs vapor and powder are hazardous to human health if inhaled or ingested.			
	Do not destroy or burn the product.			
	Do not cut or cleave off any part of the product.			
	Do not crush or chemically dissolve the product.			
	Do not put the product in the mouth.			
	Follow related laws and ordinances for disposal. The product should be excluded from general industrial waste or household garbage.			

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